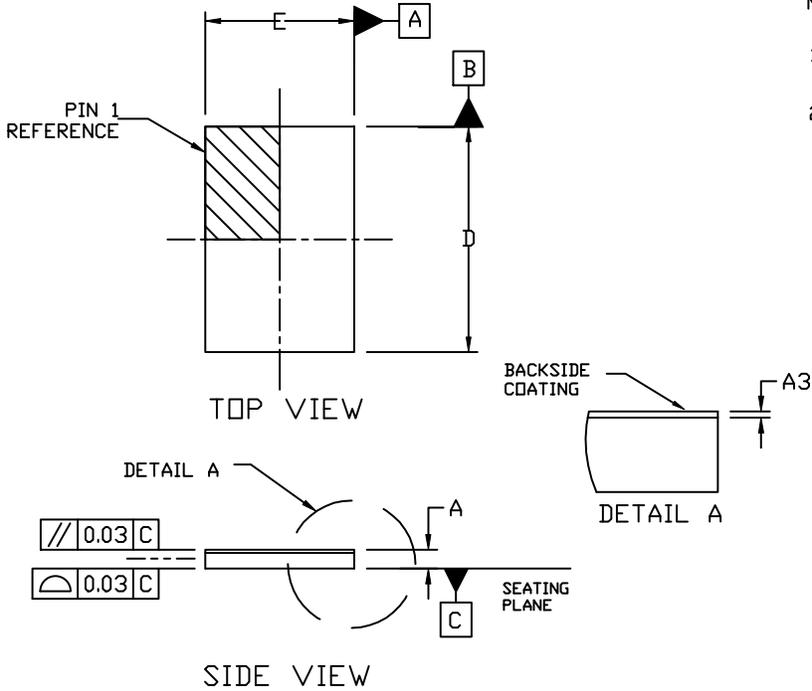


WLCSP6 1.79x1.18x0.13
CASE 567VU
ISSUE O

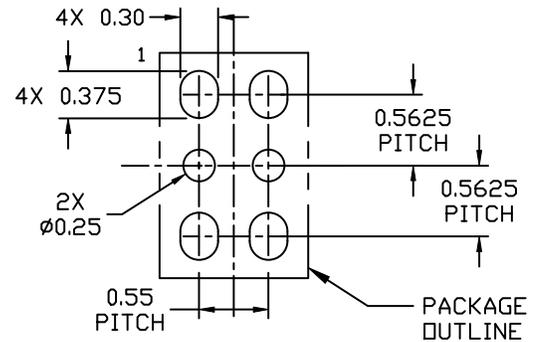
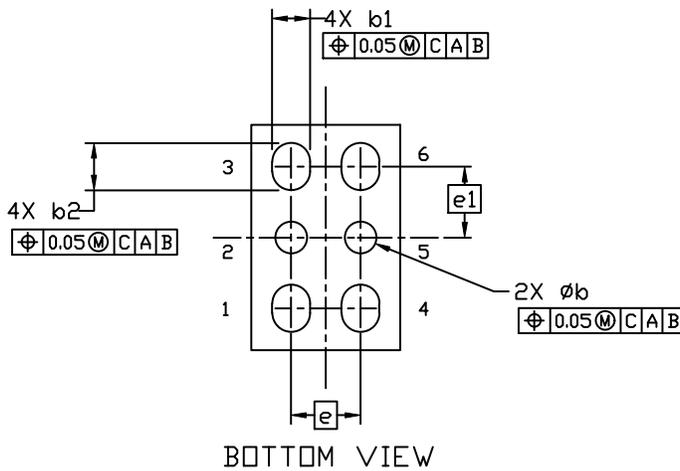
DATE 09 FEB 2018



NOTES:

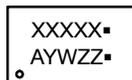
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.10	0.125	0.15
A3	0.025 REF		
b	0.22	0.25	0.28
b1	0.27	0.30	0.33
b2	0.345	0.375	0.405
D	1.76	1.79	1.82
E	1.15	1.18	1.21
e	0.55 BSC		
e1	0.5625 BSC		



RECOMMENDED MOUNTING FOOTPRINT

GENERIC MARKING DIAGRAM*



- A = Assembly Location
- Y = Year
- W = Work Week
- ZZ = Assembly Lot
- = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	WLCSP6 1.79x1.18x0.13	PAGE 1 OF 1

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